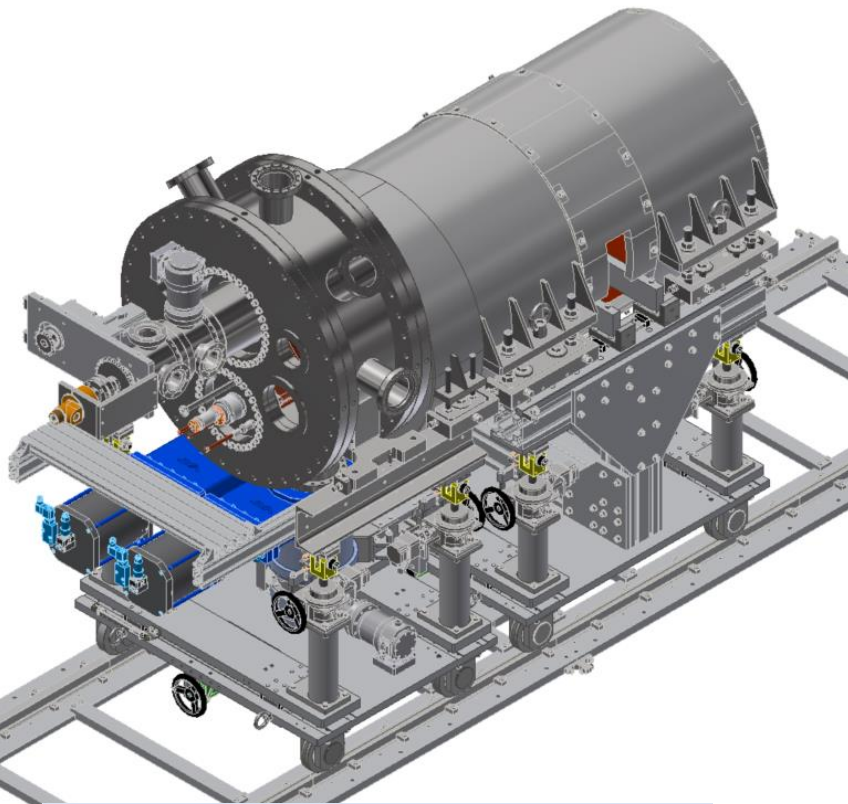
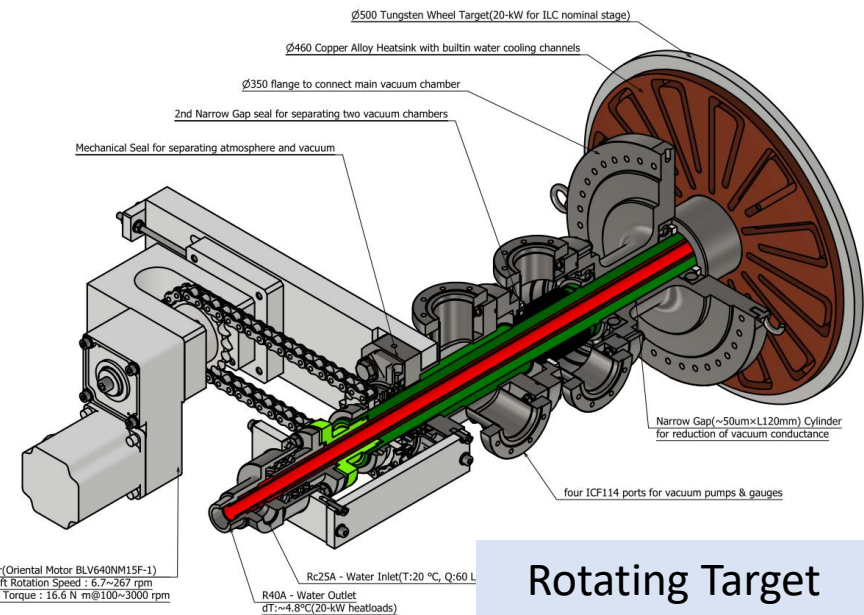


E-driven Target Status and Plans

○Yu Morikawa(KEK)



Mockup for ILC positron source



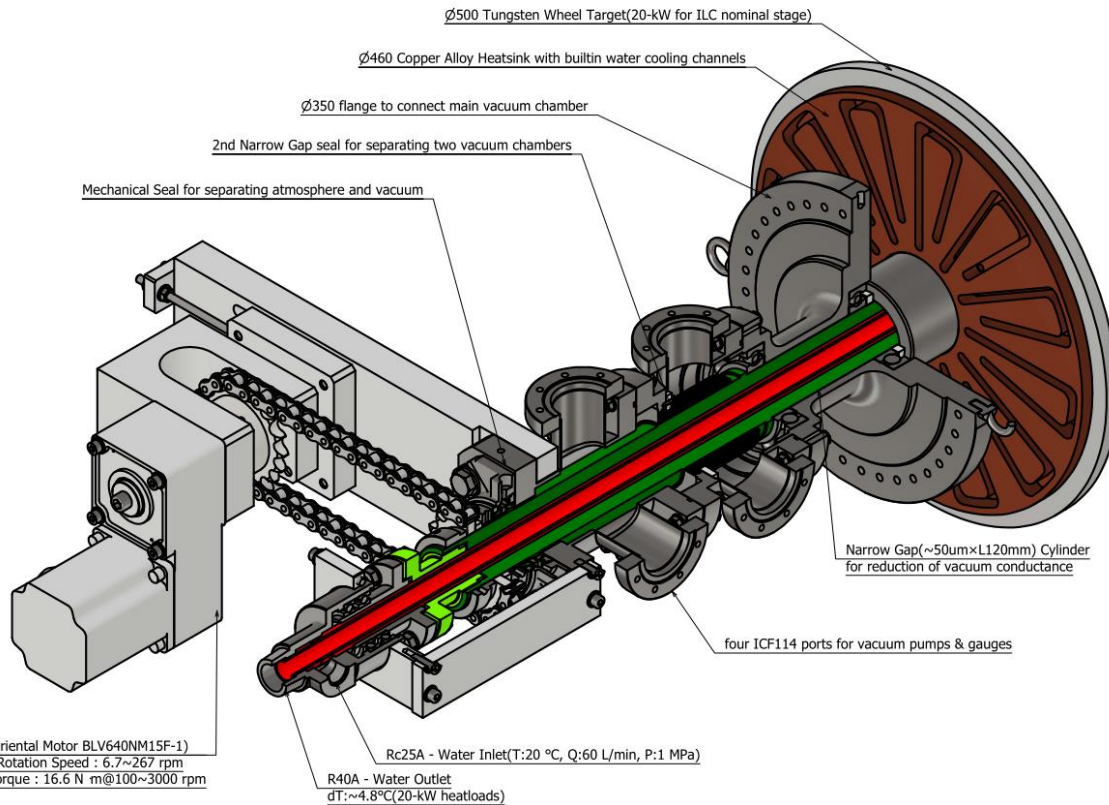
Rotating Target

- A) Mockup of rotating target
- B) Thermal & Structural analysis
- C) Target Material : W/Cu junction, Advanced tungsten.

e⁻  e⁺

Mechanical Design of Rotating Target

$\frac{3}{4}$ cut cross section



【Features of Rotating Target】

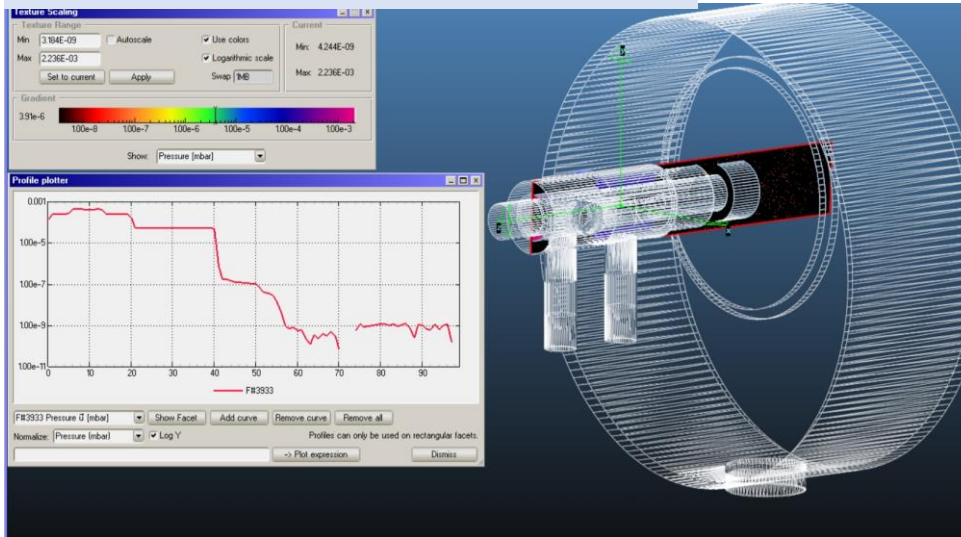
- ✓ ϕ 500mm tungsten disk
- ✓ ϕ 460mm copper alloy heat sink
- ✓ Rotation Speed : 220 rpm
- ✓ Water cooling (60L/min)
- ✓ ϕ 70mm shaft with embedded water channel
- ✓ Required vacuum $\sim 1e-6$ Pa
- ✓ Differential pumping
 - 2 additional chamber
 - Narrow Gap, Mechanical Seal

e^-

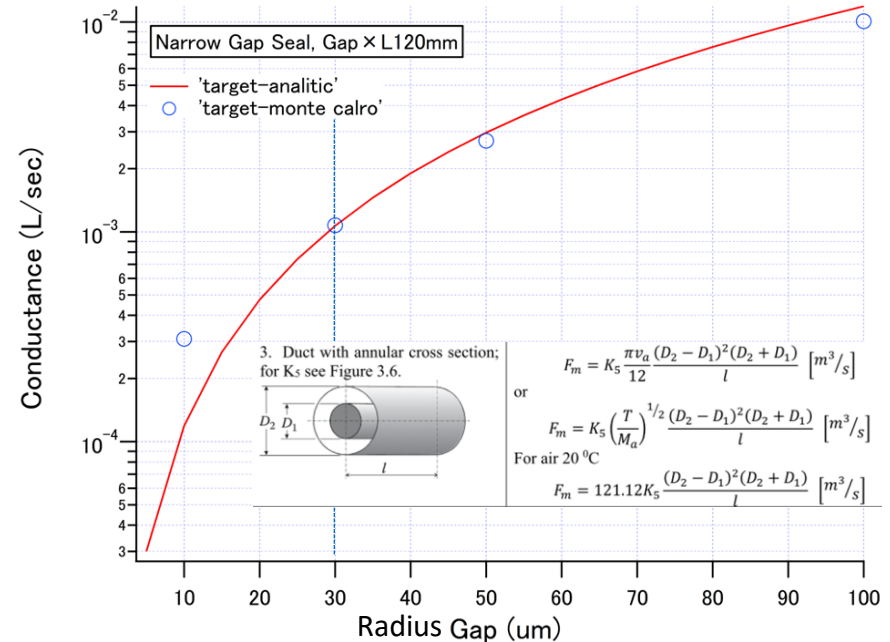
e^+

Mockup test in 2023

Vacuum Simulation by Molflow



Vacuum Conductance -Narrow Gap Seal



【1st year plan】

- ✓ Build the target mockup without Tungsten disk, FC, 1st ACC
- ✓ Rotation & Vacuum test

【Key points】

(Mechanic) Precision Machining & Assembly, Vacuum compatible component
 (Vacuum) Vacuum performance of narrow gap seal, Mechanical Seal

e⁻ ————— e⁺

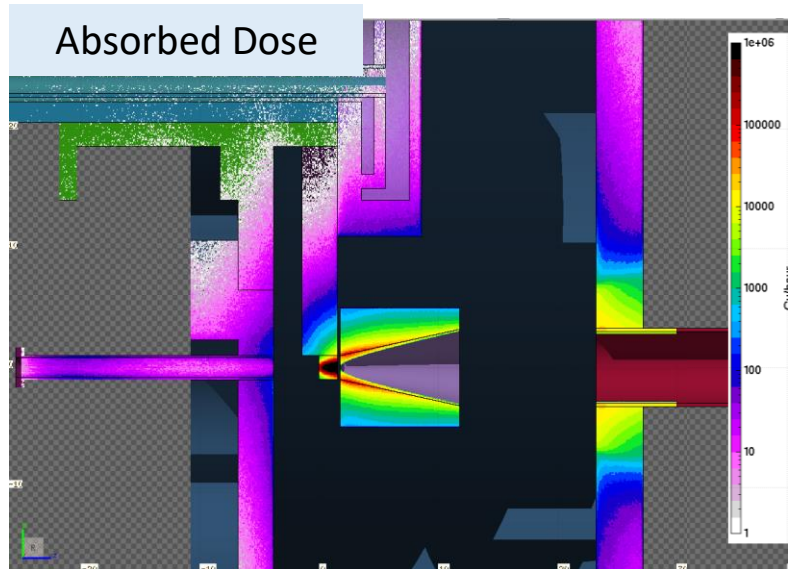
- A) Mockup of rotating target
- B) Thermal & Structural analysis
- C) Target Material : W/Cu junction, Advanced tungsten.



Thermal & Structural analysis

Preliminary Results

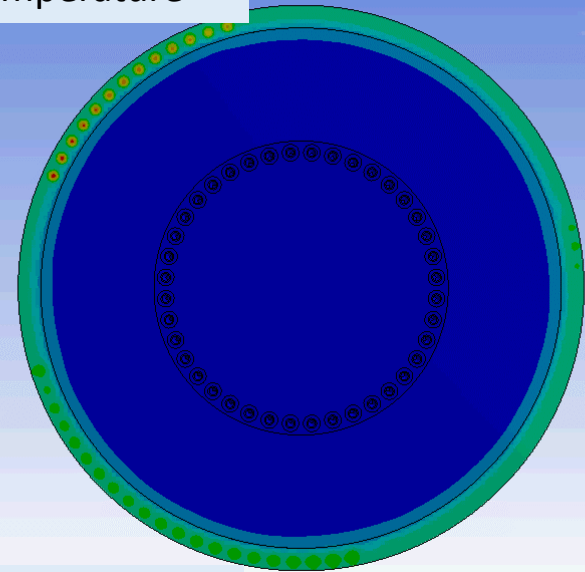
	ILC e-driven
Primary electron energy(e^-) [GeV]	3
e^- Beam power [kW]	74
e^- Beam size on target [σ - mm]	2
Target material	W (or W alloy)
Target thickness	$4.5X_0$ -(15.7mm)
Power deposition on target [kW]	18.8
PEDD*** [J/g]	33.6
Max temperature of Cu alloy [$^{\circ}\text{C}$]	~ 160
Max temperature of W [$^{\circ}\text{C}$]	~ 420
Max equivalent stress at W/Cu junction [MPa]	~ 200
Max equivalent stress at W junction [MPa]	~ 250



Temperature

時間: 7.7575
2023/03/17 17:41

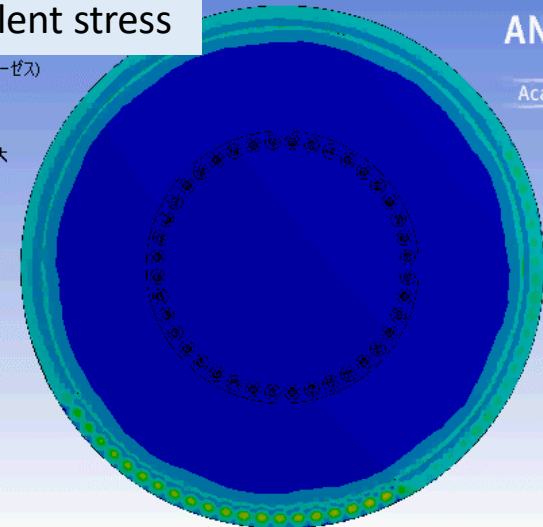
227.86 最大
205.32
182.78
160.24
137.7
115.16
92.62
70.08
47.54
25 最小



Equivalent stress

タイプ: 相当応力 (ミーゼス)
単位: Pa
時間: 7.7575

2.2751e8 最大
2.0223e8
1.7696e8
1.5168e8
1.2641e8
1.0113e8
7.5855e7
5.0579e7
2.5304e7
28144 最小



e^- ● e^+

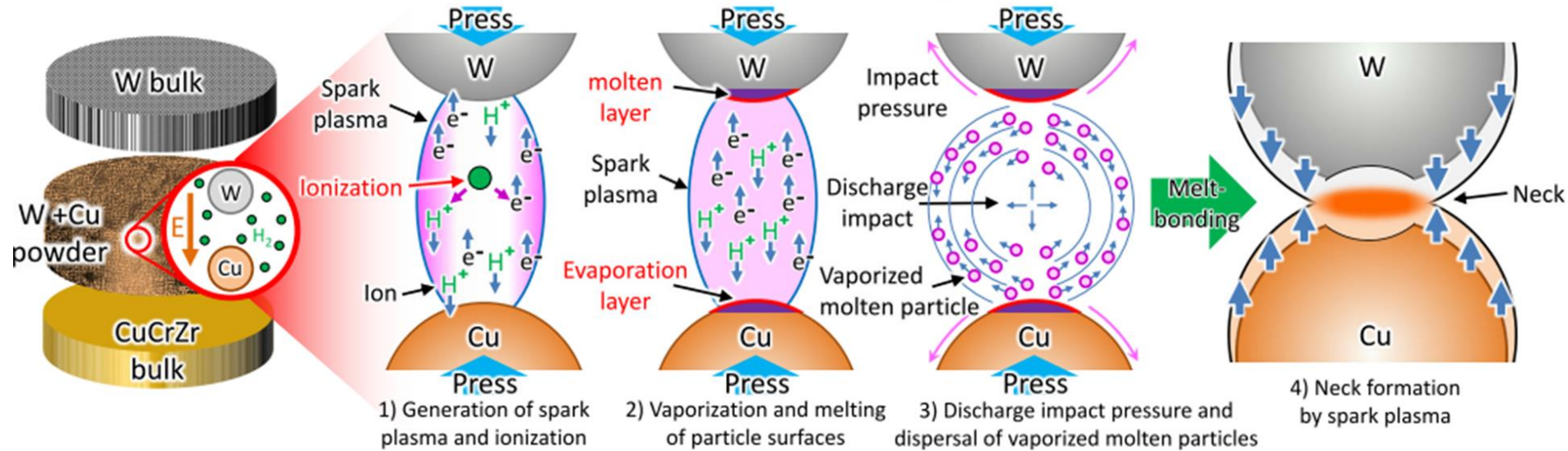
- A) Mockup of rotating target
- B) Thermal & Structural analysis
- C) Target Material : W/Cu junction, Advanced tungsten.



W/Cu Junction

Junction by Spark Plasma Sintering (SPS)*1

collaboration research with National Institute for Fusion Science (NIFS, Japan)



【SPS advantages】

- Junction process can be performed at relatively low temp of bulk material.
- Interlayer thickness and composition can be adjusted to meet design requirements.

【1st year plan】

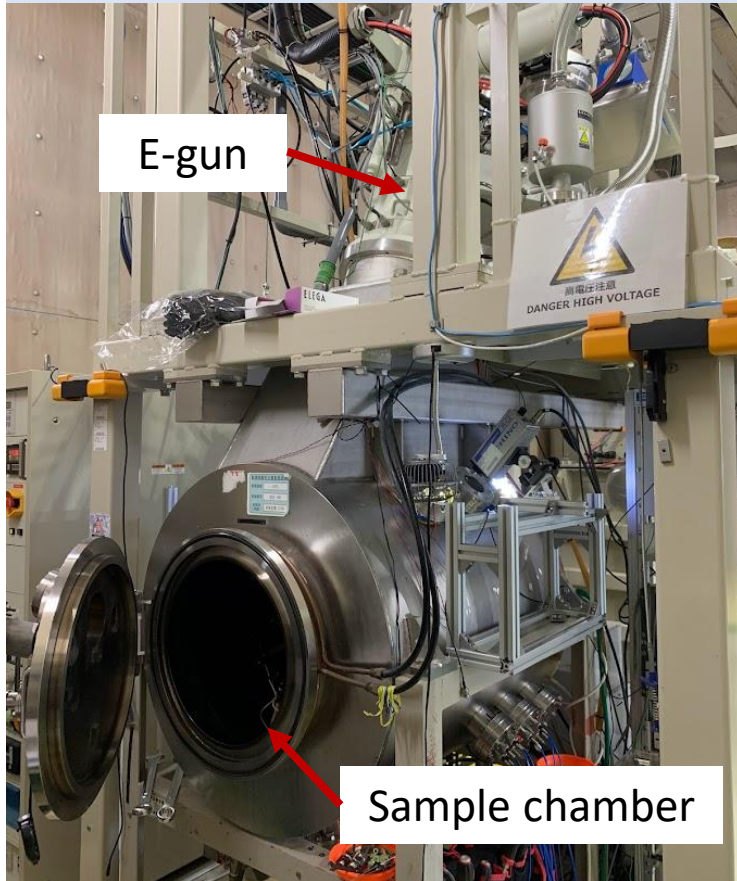
- ✓ φ40mm & φ100 test piece, thermal & mechanical test by using φ100 test piece

*1. Investigation of Joining Quality in Tungsten and Copper Alloy Joints using Spark Plasma Sintering for Plasma Facing Materials, MURASE Takanori, et al. SOFT 2022.

e^- ● e^+

Thermal Test of $\phi 100\text{mm}$ target mockup

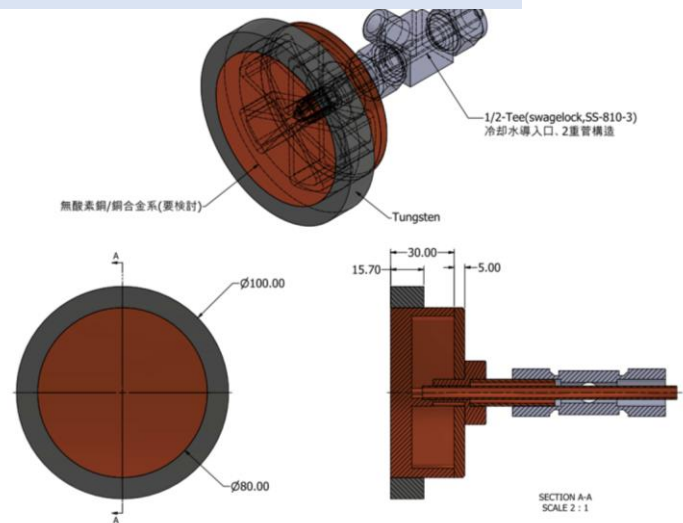
Thermal Test Facility - ACT2@ NIFS



specifications

parameters	value	unit
max. output power	300 (100)	kW
acceleration voltage	40	kV DC
max. current	7.5	A
max. scanning area	300 x 300	mm
spot size of e-beam	~ 10	mm

$\phi 100\text{mm}$ -target mockup



✓ Thermal test by electron beam - max300kW (Cooling capacity, thermal resistance at junction)



Actions in 2023

- ✓ Build target mockup and rotation & vacuum test
- ✓ Test piece of W/Cu joint by SPS
- ✓ Thermal test of $\phi 100$ target mockup by electron beam
- ✓ Investigation about advanced tungsten

